

Notice of References Cited	Application/Control No. 10/086,363	Applicant(s)/Patent Under Reexamination HASHIMOTO ET AL.	
	Examiner Jared J. Fureman	Art Unit 2876	Page 1 of 1

U.S. PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
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NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	"THERMAL COMPOUNDS, ADHESIVES, INTERFACE MATERIALS, HARDWARE, INSTALLATION TOOLS", http://www.industrialelectronics.biz/wakefld/wakep182.html , pages 1-3, copyright 1998 (no month available).
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